



M2S060TS-FGG676 Information

Heisener.com

Part NumberM2S060TS-FGG676ManufacturerMicrosemi CorporationCategoryIntegrated Circuits (ICs)

Embedded - System On Chip (SoC)

Description IC FPGA SOC 60K LUTS

Package 676-BGA

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









M2S060TS-FGG676 Specifications

Manufacturer Part Number	M2S060TS-FGG676	
Manufacturer	Microsemi Corporation	
Category	Integrated Circuits (ICs)	
Category	Embedded - System On Chip (SoC)	
Package	676-BGA	
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Series	SmartFusion?2	
Architecture	MCU, FPGA	
Core Processor	ARM? Cortex?-M3	
Flash Size	256KB	
RAM Size	64KB	
Peripherals	DDR, PCIe, SERDES	
Connectivity	CAN, Ethernet, I2C, SPI, UART/USART, USB	
Speed	166MHz	
Primary Attributes	FPGA - 60K Logic Modules	
Operating Temperature	0°C ~ 85°C (TJ)	
Package / Case	676-BGA	
Supplier Device Package	676-FBGA (27x27)	
		Report errors?

M2S060TS-FGG676 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

M2S060TS-FGG676 Payment Methods



















M2S060TS-FGG676 Shipping Methods













If you have any question about M2S060TS-FGG676, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com